

**IN THE SPECIFICATION:**

**Please amend paragraph 23 as follows:**

[0023] The resist that is sprayed with a resist provider 35 onto the substrate 20 is a liquid until it is exposed to the exposure radiation 15, at which point it sets to a solid, any unset resist being removable by a release agent.

**Please amend paragraph 25 as follows:**

[0025] There are preferably thermal elements 40 for controlling the temperature of the curved member 25 to align the patterning stamp 30 with the target portion of the substrate and for correcting the magnification of the pattern on the stamp 30. The pattern is set onto the substrate 30 with the correct alignment and at the correct magnification, otherwise the substrate 20 will not be able to serve its purpose. The border of the stamp 30 and/or the substrate 20 can be constantly monitored and the thermal elements 40 may be used either in the substrate 20 or the stamp 30 to adjust the relative positions and magnifications, even “on the fly.”

**Please amend paragraph 25 as follows:**

[0026] In order to ensure that the pattern is correctly imprinted onto the target portion of the substrate 20, alignment markers 45 are printed along the edges of the stamp 30, which are aligned with markers in scribe lanes along the edge of the substrate 20.